

Package Modeling and Return Loss Limits

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Supporters

- Your name can be here 😊

Agenda

- Present the target and motivation
- Discuss package models that were used for the analysis
- Discuss suggested package insertion loss and return loss equations for COM code
- Suggest remedies to related comments

Target and Motivation

- COM code used to evaluate interconnects lacks a representation of device package effects.
- To have a more accurate assessment of interconnects we suggest adding:
 - Package insertion loss representation equation
 - Package return loss representation equation
 - Return loss limit @ TP0a to correspond with return loss equation of the COM code

Package Models Used for the analysis

- Synthetic model were used to represent the package
- Discontinuities taken into account at both ends on the package – Die side & ball side.
 - 0.25pF was taken as die side parasitic capacitance (correlates to former suggestions).
 - Ball discontinuity was correlated to HFSS extraction results.
- Package trace took into account manufacturing tolerance inaccuracy.
- Die impedance accuracy = $\pm 5\%$
- In correlation to former PAM2 feasibility presentations package insertion loss @ Fb/2 was limited to $\sim 2.5\text{dB}$

Package Insertion Loss Modeling

- An analytic equation is meant to represent package insertion loss including loss and package level multiple reflections.
- The insertion loss equation is not meant to represent a reference package frequency domain limit.
- The insertion loss equation represents the package SNR impact.

Insertion Loss Equation Basics

- The insertion loss equation is based on a representation of pure frequency dependent loss + representation of package level distortion.

- $IL_{dB}(f) = -Lpkg(a_0 * \sqrt{f} + a_1 * f + a_2 * f^2)$

- $ILP(f) = 10^{\frac{IL_{dB}(f)}{20}} * e^{\frac{-j*2*\pi*f*lpkg}{Velocity}}$

- Distortion due to multiple reflections:

- $HP_{tx}(f) = HP_{rx}(f)$

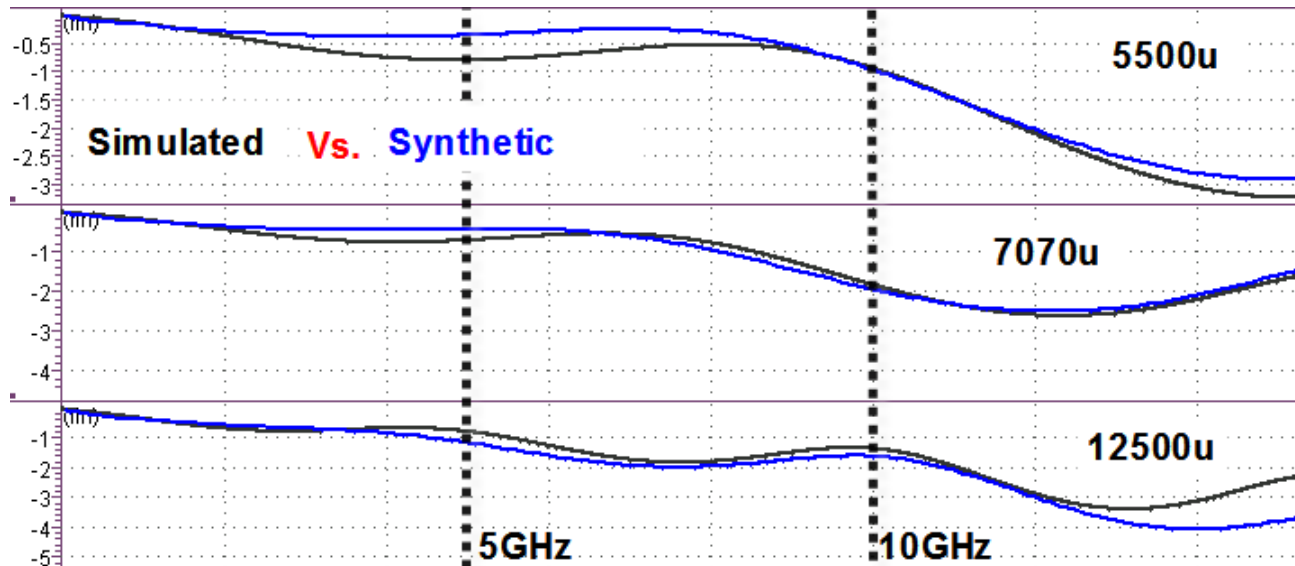
$$= \frac{ILP(f)}{1 - ((G_d(f) + G_b(f)) * \Gamma_{tl} + (G_d(f) * G_b(f)) * (ILP(f)^2 - \Gamma_{tl}^2))}$$

- $G_d(f) = \frac{-j*2500*2*\pi*f*C_d}{100 + j*2500*2*\pi*f*C_d}$

- $G_b(f) = \frac{-j*2500*2*\pi*f*C_b}{100 + j*2500*2*\pi*f*C_b}$

Insertion Loss Model – Simulation Correlation

- The parameters of the mathematical representation were optimized according to simulation results (and may be further tweaked).
- Mathematical model was shown to have a reasonable correlation to the simulated insertion loss.
- Reference code in backup slides



Parameter	Value
A0	8E-10
A1	4.2E-15
A2	5.1E-25
Velocity	182E12
Die_cap	0.25pF
Ball_cap	0.22pF

Voltage gain for package inclusion into channel gain depends on package/die model

$$H_{21proposed1} = \frac{S_{21}}{1 - S_{11}\Gamma_{TX} - S_{22}\Gamma_{RX} - S_{21}S_{12}\Gamma_{TX}\Gamma_{RX} + S_{11}\Gamma_{TX}S_{22}\Gamma_{RX}}$$

Gain based on waves

$$H_{21proposed2} = \frac{S_{21} (1 + \Gamma_{RX})(1 - \Gamma_{TX})}{1 - S_{11}\Gamma_{TX} - S_{22}\Gamma_{RX} - S_{21}S_{12}\Gamma_{TX}\Gamma_{RX} + S_{11}\Gamma_{TX}S_{22}\Gamma_{RX}}$$

Gain based on ideal voltage source

$$H_{21proposed3} = \frac{S_{21} (1 + \Gamma_{RX})}{1 - S_{11}\Gamma_{TX} - S_{22}\Gamma_{RX} - S_{21}S_{12}\Gamma_{TX}\Gamma_{RX} + S_{11}\Gamma_{TX}S_{22}\Gamma_{RX}}$$

Gain based in voltage source with parallel RC

$$H_{21proposed4} = \frac{S_{21} (1 - \Gamma_{TX})}{1 - S_{11}\Gamma_{TX} - S_{22}\Gamma_{RX} - S_{21}S_{12}\Gamma_{TX}\Gamma_{RX} + S_{11}\Gamma_{TX}S_{22}\Gamma_{RX}}$$

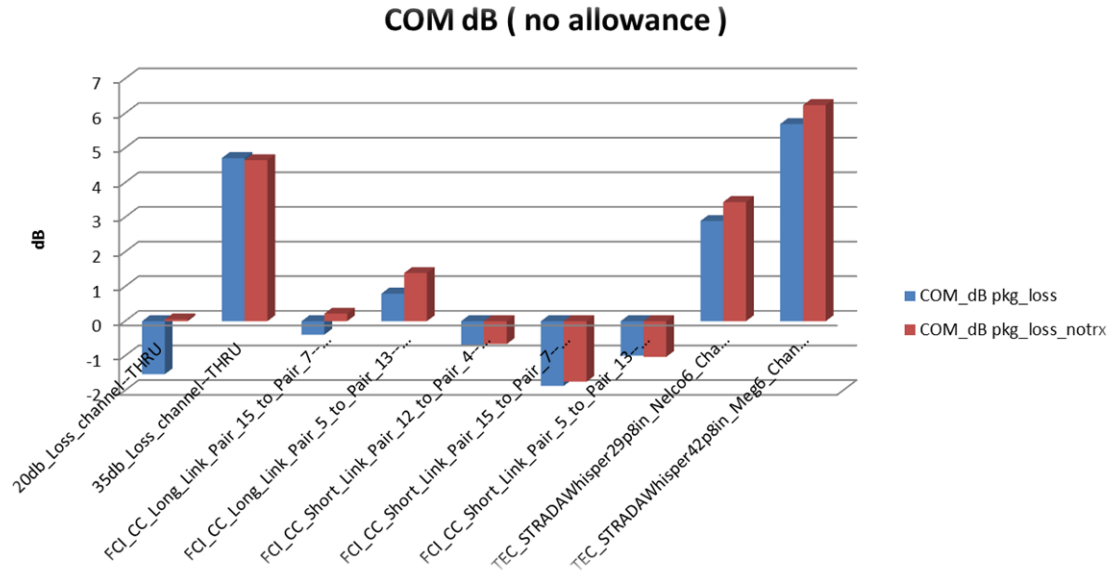
Gain based voltage source with series R and C parallel with channel

To be resolved by consensus

All following data used proposal 1 (only expect 1dB difference between any of the methods)

Comment 130: Risetime filter

- It can be seen that when the package is considered in the channel rise time impact is < 1 dB of COM on passing channels
- $\Gamma = 0.315$ F=.8Fb package model and h21(f) proposal 1 used
- Added pkg. loss to through and crosstalk channels
- Recommendation: Keep risetime filter.



Return Loss Limits and Model for COM

- Package return loss simulations were compared to several possible limits using

$$RL \geq 20 \log_{10} \left(ABS \left| \frac{\text{Gamma} - \left(i \frac{f}{F1} \right)}{1 + \left(i \frac{f}{F1} \right)} \right| \right)$$

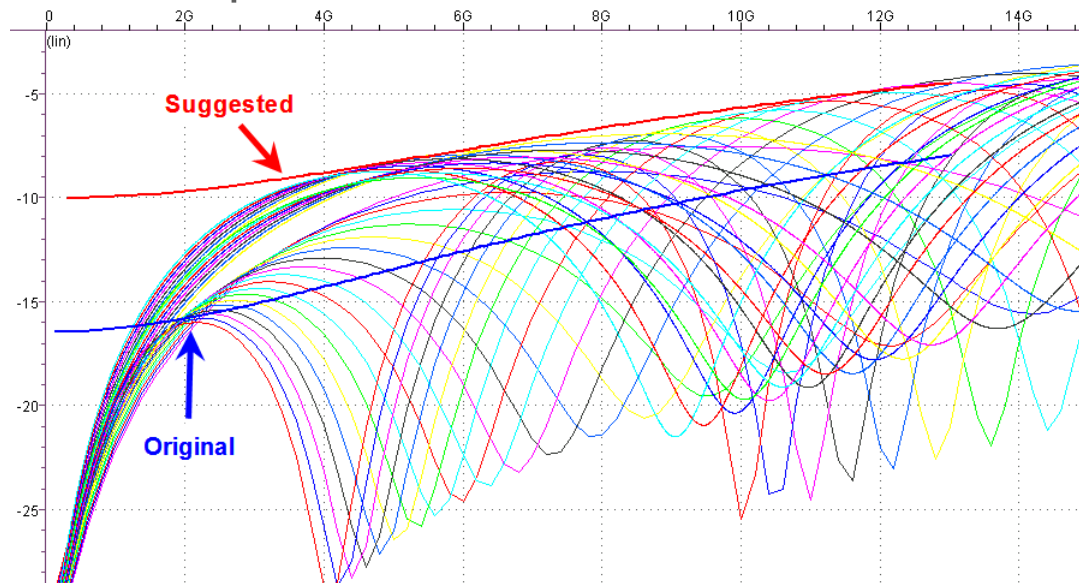
- The return loss limit equation was used in the COM code to determine the SNR impact amount.

$$RL = \left(\frac{\text{Gamma} - \left(i \frac{f}{F1} \right)}{1 + \left(i \frac{f}{F1} \right)} \right)$$

- ➔ recommend Gamma and F1 values for the return loss equation in the COM code.
- Extrapolate the Gamma and F1 values from TP0 to TP0a and suggest return loss equation limits.

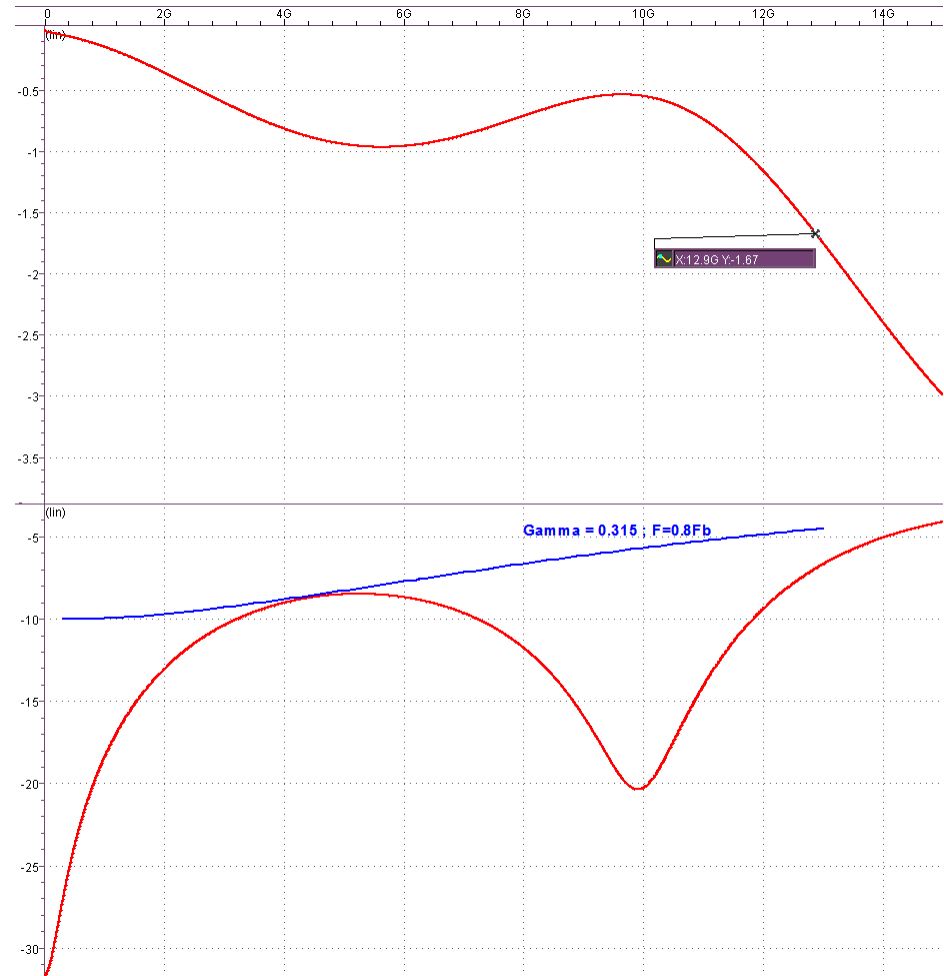
Return Loss Target COM Analysis

- Reference return loss was proven to be non feasible in real case package.
- The recommendation for return loss equation is:
 $\text{Gamma} = 0.315$ & $F = 0.8F_b$
- The suggested return loss impact was very similar to other return loss suggestions, which could limit package optimization possibilities.



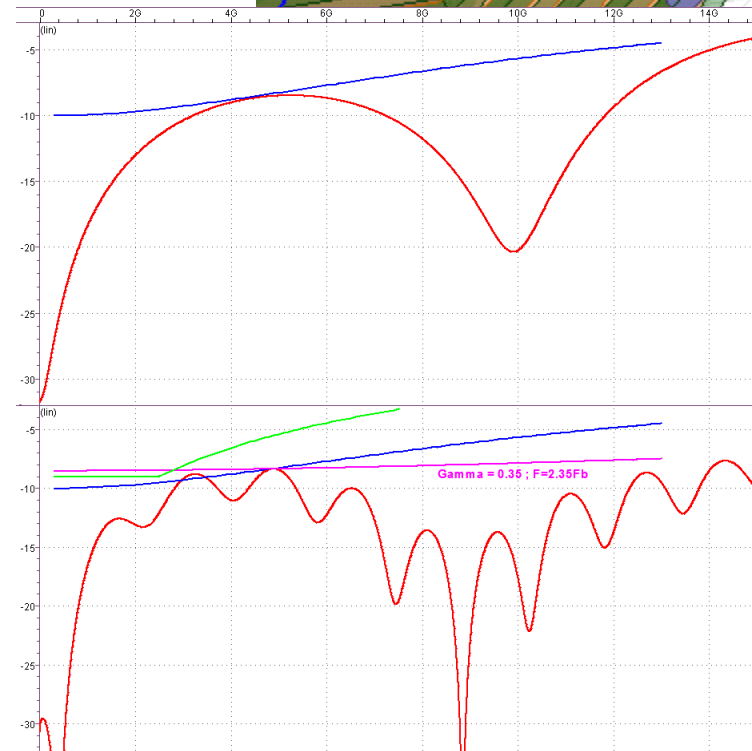
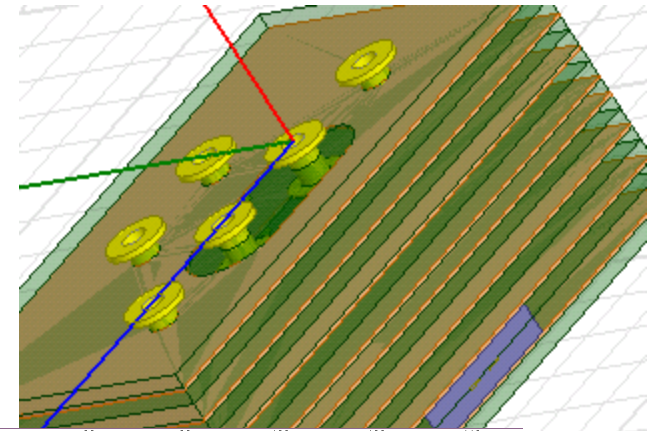
Package Suggested Return Loss Limit

- Examine the return loss of the following package:
- Package designed to have:
 - Return loss meets:
($\Gamma = 0.315$, $F1 = 0.8Fb$)
 - Loss @ $Fb/2 < 2.5\text{dB}$
(easy to get lower loss @ $Fb/2$)
- Recommend PAM4 to follow the same target with max freq = 10GHz (third harmonic of 3300...)



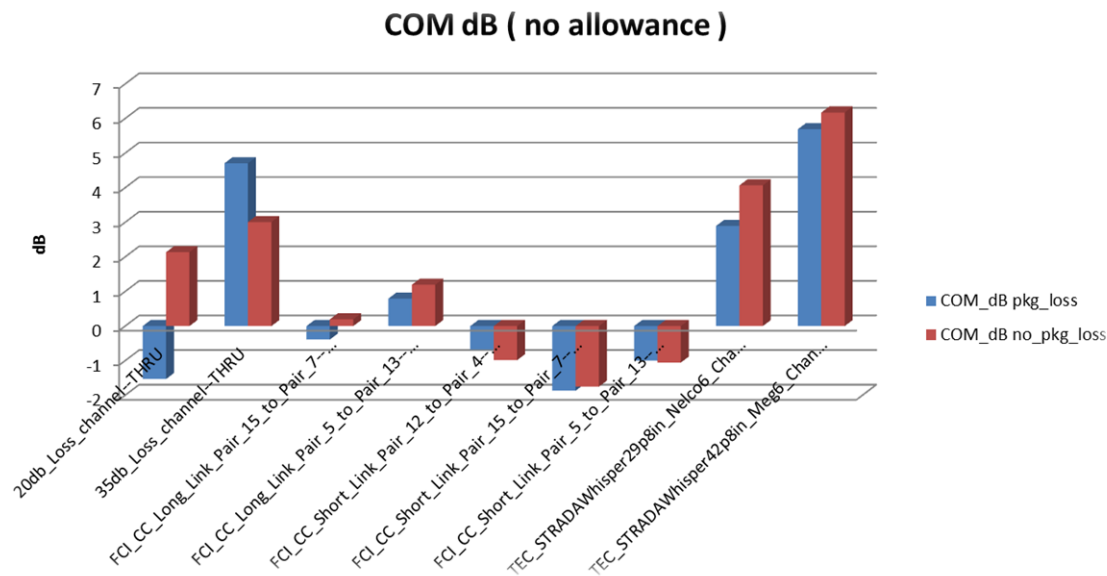
Package Suggested Return Loss TP0a Limit.

- Recommend measured return loss limit as measured through a fixture that correlates to BenArtsi_01_0912
 - $\Gamma = 0.35$
 - $F = 2.35F_b$
- Low frequency updated upward to allow multi-reflection between chip and interconnect.
- High frequency updated downward to account for fixture loss.
- Correlates to ($\Gamma = 0.315$, $F_1 = 0.8F_b$) on device pins.



Package Insertion Loss Affects COM

- Gamma = 0.315 F=.8Fb package model and h21(f) proposal 1 used
- Added pkg. loss to through and crosstalk channels
- > 1 dB impact on some channels is uniquely colored by combination of ILD, crosstalk, and loss
 - Not obvious without detailed examination of ILD, crosstalk, and losses, detailed data in backup



Conclusions / recommendations

- Comment 130 (double counting rise time filtering)
 - Recommend: Keep tx filter
- Comments 168 & 169 & 422 (package return loss model)
 - Correct Equations 93-a3 and 93-a4 to follow eq. on slide 11 and Mellitz_01_0712 slide 13 which are equivalent (reasoning on slide 19)
 - Recommend: Use corrected equation 93a-3 with $\Gamma = 0.315$; $F1 = 0.8Fb$
- Comment 167 & 171 (measured return loss limit @TP0a / TP5a)
 - Recommend: Use eq. of slide 11 with the following values: $\Gamma = 0.35$; $F1 = 2.35$
- Comment 170 & 422 – (Package insertion loss model)
 - Recommend: Add package insertion loss equation according to slide 7 with coefficients according to slide 8.

Thank you

Backup slides

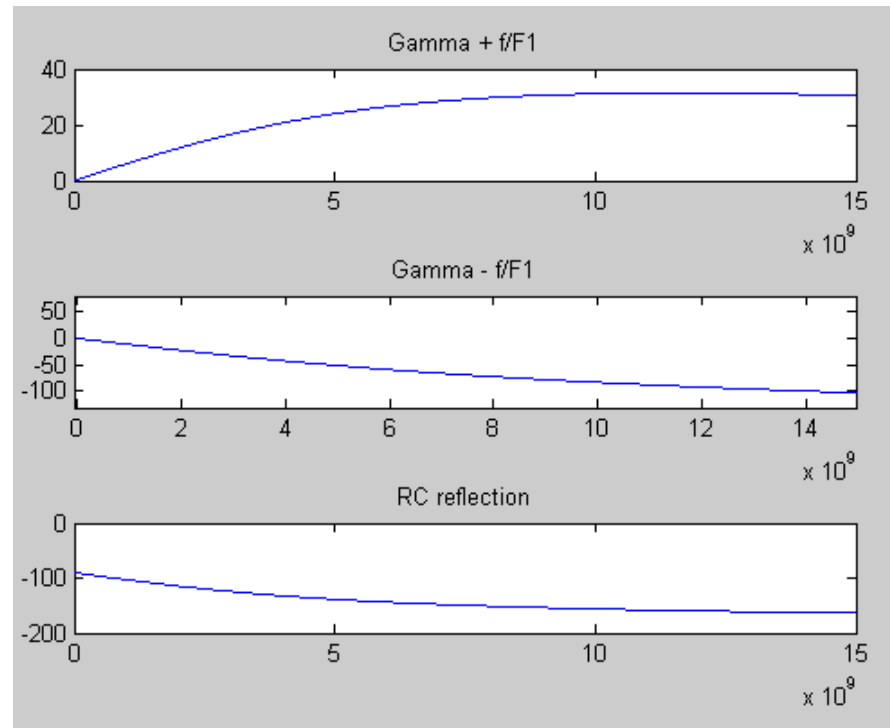
Why Fix Eq. 93-A3

- To get the phase to behave similarly to reflection from a capacitive load change:

$$RL = \left(\frac{\text{Gamma} + \left(i \frac{f}{F1} \right)}{1 + \left(i \frac{f}{F1} \right)} \right)$$

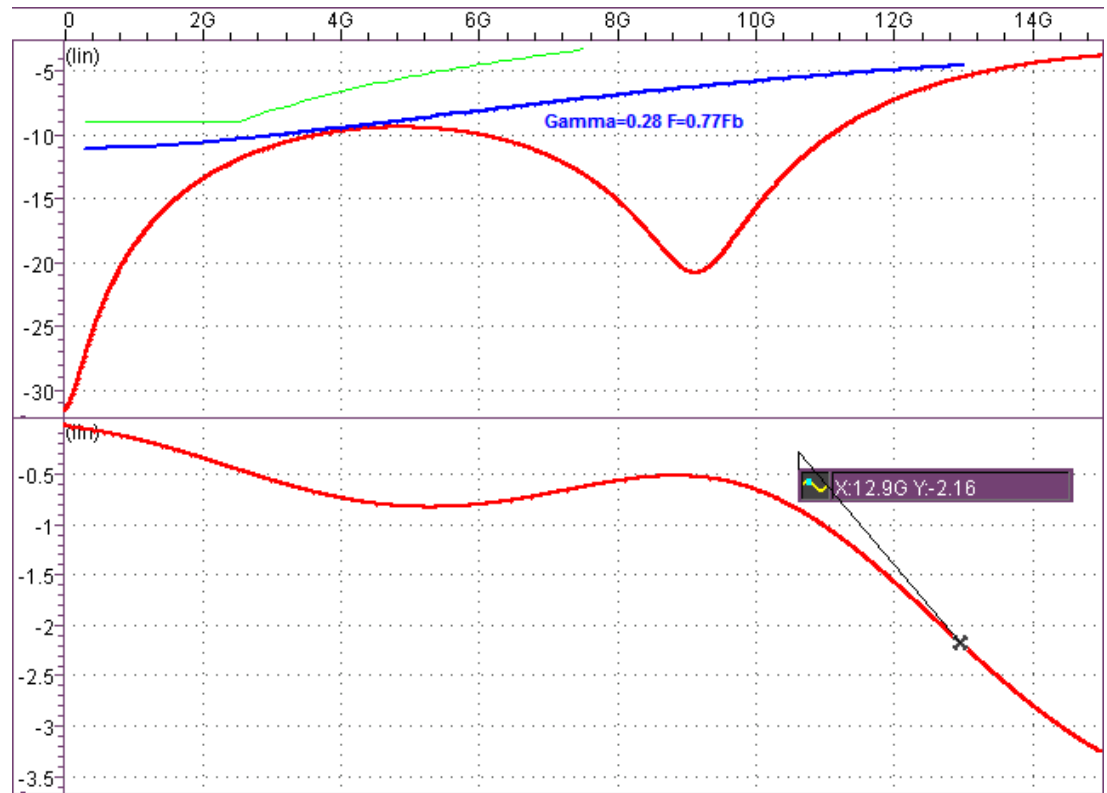
to:

$$RL = \left(\frac{\text{Gamma} - \left(i \frac{f}{F1} \right)}{1 + \left(i \frac{f}{F1} \right)} \right)$$



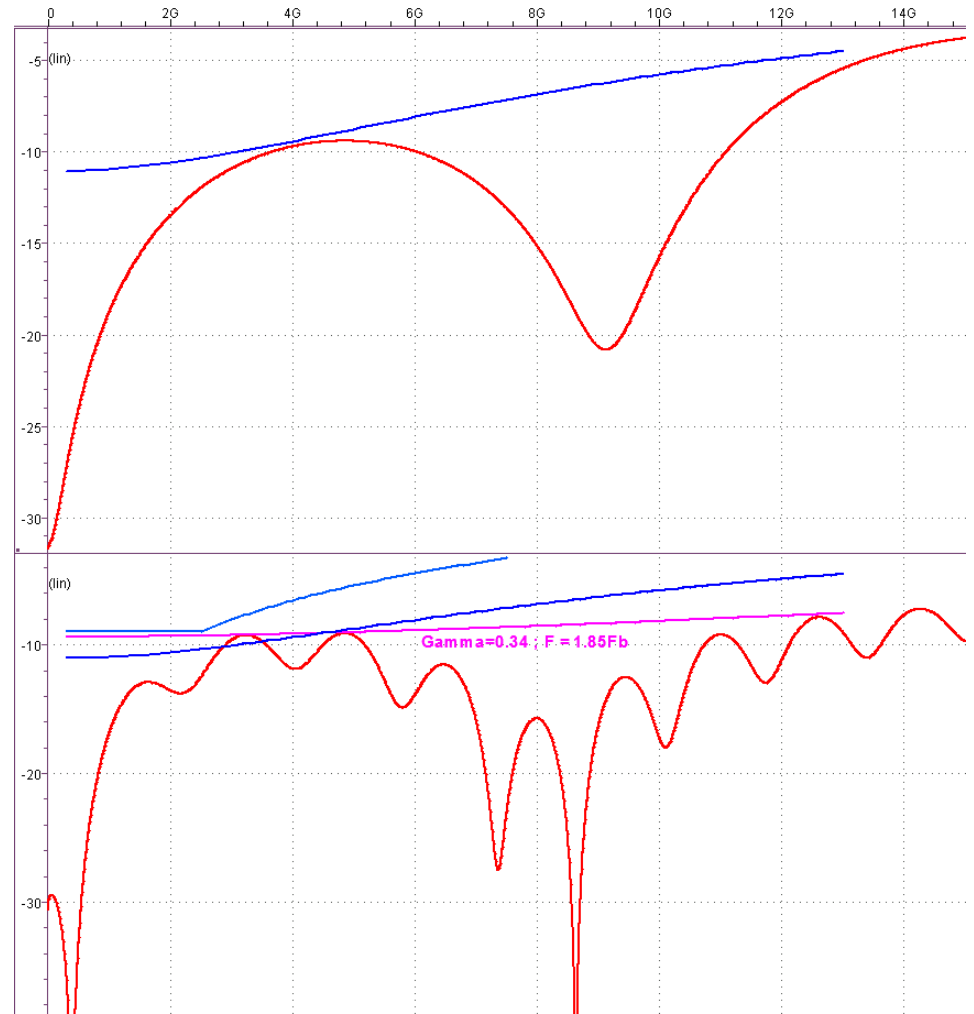
Package Return Loss Limit option #2

- Examine the return loss of the following package:
- Package designed to have:
 - Return loss meets:
Li (0.28 ,0.77Fb)
 - Loss @Fb/2 <2.5dB



Package Return Loss Option #2 – TP0a Limit

- Suggested measured return loss limit:
 - $\Gamma = 0.34$
 - $F = 1.85F_b$
- Low frequency updated upward to allow multi-reflection between chip and interconnect.
- High frequency updated downward to account for fixture loss.
- Correlates to Li (0.28 ,0.77Fb) at device pins.



Reference code

```
a0 = 8e-10;
a1 = 4.2E-15;
a2 = 5.1e-25;
Length = ; % insert value in microns
Vel = 182E12;
C_die = 0.25e-12;
C_ball = 0.22e-12;
Pure_Loss_dB = -Length * (a0*sqrt(f) + a1*f + a2*f.^2);
Pure_Loss = 10.^(Pure_Loss_dB / 20) .* exp(-1i*2*pi*f*Length/Vel);
G_die = -2500*1i*2*pi*f*C_die./(100+2500*1i*2*pi*f*C_die);
G_ball = -2500*1i*2*pi*f*C_ball./(100+2500*1i*2*pi*f*C_ball);
S11 = 0.056;
S22 = S11;
H_f = Pure_Loss ./ (1 - (G_die.* S11 + G_ball.*S22 + G_die.*G_ball.*Pure_Loss.^2 -
G_die.*G_ball.*S11.*S22));
```

Data: pkg loss, pkg loss no trf filter, no pkg loss

No pkg loss, Trf filter

File set	COM_dB	no_pkg	peak_inte	peak_char	peak_ISI	peak_MD	ICN	peak_MDI	peak_MDI	fit_loss_d	IL_loss_dE	ILD RMS	available_
20db_Loss_channel--THRU	2.14	25.90	22.70	20.10	6.20	2.94	0.00	6.20	22.44	24.11	0.91	33.12	
35db_Loss_channel--THRU	3.01	8.20	6.80	6.20	0.60	1.23	0.00	0.60	33.60	36.00	1.03	11.59	
FCI_CC_Long_Link_Pair_15_to_Pair_7--FCI_CC_Long_Link_Pair_15_to_Pair_7_Through	0.20	58.10	52.40	48.10	12.30	2.32	10.90	2.00	17.96	16.78	1.34	59.42	
FCI_CC_Long_Link_Pair_5_to_Pair_13--FCI_CC_Long_Link_Pair_5_to_Pair_13_Through	1.19	55.80	49.50	44.60	12.10	2.54	10.40	2.30	17.61	15.71	1.03	64.03	
FCI_CC_Short_Link_Pair_12_to_Pair_4--FCI_CC_Short_Link_Pair_12_to_Pair_4_Through	-0.99	259.40	236.70	233.10	24.20	5.24	17.20	12.80	3.37	3.00	1.60	231.57	
FCI_CC_Short_Link_Pair_15_to_Pair_7--FCI_CC_Short_Link_Pair_15_to_Pair_7_Through	-1.75	272.60	251.20	247.10	26.90	5.46	19.80	14.30	3.33	2.06	2.08	222.84	
FCI_CC_Short_Link_Pair_5_to_Pair_13--FCI_CC_Short_Link_Pair_5_to_Pair_13_Through	-1.05	271.80	248.00	240.90	31.90	7.10	20.30	20.20	3.12	4.26	1.68	240.73	
TEC_STRADAWhisper29p8in_Nelco6_Channel_IEEE802_3_100GbCu_04282011--TEC_Whisper	4.07	7.30	5.70	2.30	3.40	1.38	2.80	0.60	34.19	34.98	0.33	11.66	
TEC_STRADAWhisper42p8in_Meg6_Channel_IEEE802_3_100GbCu_04282011--TEC_Whisper	6.18	10.00	7.50	3.70	3.80	1.59	2.60	1.20	26.83	27.28	0.27	20.36	

Pkg loss, Trf filter

File set	COM_dB	peak_inte	peak_char	peak_ISI	peak_MD	ICN	peak_MDI	peak_MDI	fit_loss_d	IL_loss_dE	ILD RMS	available_
20db_Loss_channel--THRU	-1.53	17.50	16.20	14.80	2.60	2.94	0.00	2.60	22.44	24.11	0.91	14.67
35db_Loss_channel--THRU	4.71	3.90	2.90	2.90	0.00	1.23	0.00	0.00	33.60	36.00	1.03	6.71
FCI_CC_Long_Link_Pair_15_to_Pair_7--FCI_CC_Long_Link_Pair_15_to_Pair_7_Through	-0.39	27.70	25.10	22.00	5.50	2.32	4.90	0.60	17.96	16.78	1.34	26.49
FCI_CC_Long_Link_Pair_5_to_Pair_13--FCI_CC_Long_Link_Pair_5_to_Pair_13_Through	0.80	25.90	22.90	18.40	5.70	2.54	4.60	1.10	17.61	15.71	1.03	28.38
FCI_CC_Short_Link_Pair_12_to_Pair_4--FCI_CC_Short_Link_Pair_12_to_Pair_4_Through	-0.68	165.50	150.50	148.70	13.40	5.24	8.80	6.80	3.37	3.00	1.60	153.06
FCI_CC_Short_Link_Pair_15_to_Pair_7--FCI_CC_Short_Link_Pair_15_to_Pair_7_Through	-1.87	179.70	165.80	163.70	15.70	5.46	10.70	8.60	3.33	2.06	2.08	144.93
FCI_CC_Short_Link_Pair_5_to_Pair_13--FCI_CC_Short_Link_Pair_5_to_Pair_13_Through	-0.99	175.10	159.70	156.10	18.00	7.10	10.10	12.10	3.12	4.26	1.68	156.17
TEC_STRADAWhisper29p8in_Nelco6_Channel_IEEE802_3_100GbCu_04282011--TEC_Whisper	2.89	4.40	3.60	1.60	2.00	1.38	1.80	0.20	34.19	34.98	0.33	6.14
TEC_STRADAWhisper42p8in_Meg6_Channel_IEEE802_3_100GbCu_04282011--TEC_Whisper	5.69	5.40	3.90	1.70	2.20	1.59	1.60	0.60	26.83	27.28	0.27	10.40

Pkg loss, no Trf filter

File set	COM_dB	peak_inte	peak_char	peak_ISI	peak_MD	ICN	peak_MDI	peak_MDI	fit_loss_d	IL_loss_dE	ILD RMS	available_
20db_Loss_channel--THRU	0.05	19.30	17.40	15.80	3.60	3.14	0.00	3.60	22.44	24.11	1.22	19.42
35db_Loss_channel--THRU	4.65	4.20	3.20	3.10	0.10	1.28	0.00	0.10	33.60	36.00	1.44	7.17
FCI_CC_Long_Link_Pair_15_to_Pair_7--FCI_CC_Long_Link_Pair_15_to_Pair_7_Through	0.22	33.30	29.90	26.60	6.70	2.39	5.90	0.80	17.96	16.78	1.64	34.14
FCI_CC_Long_Link_Pair_5_to_Pair_13--FCI_CC_Long_Link_Pair_5_to_Pair_13_Through	1.39	31.80	28.00	24.40	6.20	2.64	4.60	1.60	17.61	15.71	1.22	37.32
FCI_CC_Short_Link_Pair_12_to_Pair_4--FCI_CC_Short_Link_Pair_12_to_Pair_4_Through	-0.66	188.50	171.20	169.00	15.40	5.53	9.00	9.60	3.37	3.00	1.90	174.70
FCI_CC_Short_Link_Pair_15_to_Pair_7--FCI_CC_Short_Link_Pair_15_to_Pair_7_Through	-1.75	204.10	188.00	185.50	17.70	5.69	11.20	10.70	3.33	2.06	2.55	166.90
FCI_CC_Short_Link_Pair_5_to_Pair_13--FCI_CC_Short_Link_Pair_5_to_Pair_13_Through	-1.03	200.50	182.70	178.00	21.70	7.44	11.20	15.70	3.12	4.26	1.96	178.06
TEC_STRADAWhisper29p8in_Nelco6_Channel_IEEE802_3_100GbCu_04282011--TEC_Whisper	3.44	4.60	3.60	1.60	2.00	1.39	1.80	0.20	34.19	34.98	0.41	6.84
TEC_STRADAWhisper42p8in_Meg6_Channel_IEEE802_3_100GbCu_04282011--TEC_Whisper	6.24	5.70	4.00	1.80	2.20	1.61	1.60	0.60	26.83	27.28	0.31	11.69

Parameter	Setting	Config/Interface Types	Operational Control		
Coding/Port Type	NRZ Clause 93 D1.1	NRZ Clause 93	INCLUDE_CTL	1	
Unit Interval (UI)	3.87879E-11	NRZ/FEC Clause 93	INCLUDE_FILTER	1	
tx_ffe	[.1 .4]	PAM4 Clause 94	DEBUG	0	
ndfe	12	NRZ Clause 93 D1.1	DISPLAY_WINDOW	1	
max_ctle	12	NRZ/FEC Clause 93 D1.1	CSV_REPORT	1	
a_thru	0.4	PAM4 Clause 94 D1.1	SAVE_RESP	0	
a_fext	0.4		GET_FD	1	
a_next	0.6		INC_PACKAGE	1	
AG	1		USE_EXTERNAL_PARAM	0	
specBER	1.00E-12		RESULT_DIR	\Pkg_loss\	
Allowance	0		PKG_LOSS	1	
G_s_noise	0.01				
g_dd_noise	0.1				
Na_rms	0				
Samples Per UI	32				
Port Order	[1 3 2 4]				
G01	0.315				
G02	0.315				
Fscale1	0.77				
Fscale2	0.77				
ctle_step	1				
tx_ffe_step	0.02				
maxc1	1				
maxcx	1				
f_v	0.55				
f_f	0.55				
f_n	1				
f_r	0.75				

COM spreadsheet for pkg. loss

Parameter	Setting	Config/Interface Types	Operational Control		
Coding/Port Type	NRZ Clause 93 D1.1	NRZ Clause 93	INCLUDE_CTL	1	
Unit Interval (UI)	3.87879E-11	NRZ/FEC Clause 93	INCLUDE_FILTER	1	
tx_ffe	[.1 .4]	PAM4 Clause 94	DEBUG	0	
ndfe	12	NRZ Clause 93 D1.1	DISPLAY_WINDOW	1	
max_ctle	12	NRZ/FEC Clause 93 D1.1	CSV_REPORT	1	
a_thru	0.4	PAM4 Clause 94 D1.1	SAVE_RESP	0	
a_fext	0.4		GET_FD	1	
a_next	0.6		INC_PACKAGE	1	
AG	1		USE_EXTERNAL_PARAM	0	
specBER	1.00E-12		RESULT_DIR	g_loss_notrx\	
Allowance	0		PKG_LOSS	1	
G_s_noise	0.01				
g_dd_noise	0.1				
Na_rms	0				
Samples Per UI	32				
Port Order	[1 3 2 4]				
G01	0.315				
G02	0.315				
Fscale1	0.77				
Fscale2	0.77				
ctle_step	1				
tx_ffe_step	0.02				
maxc1	1				
maxcx	1				
f_v	3				
f_f	3				
f_n	3				
f_r	0.75				

COM spreadsheet
for pkg. loss no
risetime filter